

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: TB1911-01 DATE: November 18, 2019 Product Affected: HS3001, HS3002, HS3003, HS3004 (Shipment in Reel form) Date Effective: February 18, 2020			MEANS OF DISTINGUISHING CHANGED DEVICES: Product Mark Back Mark Date Code Other Refer to PCN for effective date		
	T PCN DESK <u>t-pcn@lm.renesas.com</u>	1	Attachment: Samples:	Yes N/A	No
DESCRIPTION AND PURPOSE OF CHANGE: Die Technology Wafer Fabrication Process Assembly Process Equipment Material Testing Manufacturing Site Data Sheet Other - Packaging					
RELIABILITY/QUALIFICATION SUMMARY: N/A					
CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.					
Customer:			Approval fo	r shipments prior to eff	ective date.
Name/Date:		E-M	Mail Address:		
Title:		Pho	one# /Fax# :		
CUSTOMER COMMENTS:					
IDT ACKNOWLEDGMENT OF RECEIPT:					
RECD. BY:			DATE:		